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TOSHIBA Field-Effect Transistor Silicon N / P Channel MOS Type

# SSM6L35FU

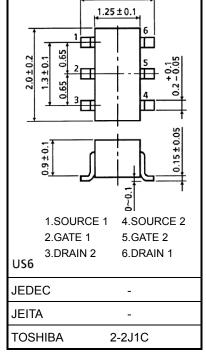
- High-Speed Switching Applications
- Analog Switch Applications
- N-ch: 1.2-V drive P-ch: 1.2-V drive
- N-ch, P-ch, 2-in-1
- Low ON-resistance Q1 N-ch:  $R_{on}$  = 20  $\Omega$  (max) (@V<sub>GS</sub> = 1.2 V)

 $\begin{array}{rl} : {\sf R}_{\sf on} = & 8 \; \Omega \; ({\sf max}) \; (@{\sf V}_{\sf GS} = 1.5 \; {\sf V}) \\ : {\sf R}_{\sf on} = & 4 \; \Omega \; ({\sf max}) \; (@{\sf V}_{\sf GS} = 2.5 \; {\sf V}) \\ : {\sf R}_{\sf on} = & 3 \; \Omega \; ({\sf max}) \; (@{\sf V}_{\sf GS} = 4.0 \; {\sf V}) \\ {\sf Q2} \; {\sf P}\text{-ch:} \; {\sf R}_{\sf on} = 44 \; \Omega \; ({\sf max}) \; (@{\sf V}_{\sf GS} = -1.2 \; {\sf V}) \end{array}$ 

- :  $R_{on} = 22 \Omega (max) (@V_{GS} = -1.5 V)$
- :  $R_{on}$  = 11  $\Omega$  (max) (@V<sub>GS</sub> = -2.5 V)
- :  $R_{on} = 8 \Omega (max) (@V_{GS} = -4.0 V)$

#### Q1 Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage	V <sub>DSS</sub>	20	V	
Gate-source voltage		V <sub>GSS</sub>	±10	V
Drain current	DC	۱ <sub>D</sub>	180	mA
	Pulse	I <sub>DP</sub>	360	ША



2.1±0.1

Weight: 6.8 mg (typ.)

#### Q2 Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V <sub>DSS</sub>	-20	V
Gate-source voltage		V <sub>GSS</sub>	±10	V
Drain current	DC	۱ <sub>D</sub>	-100	mA
Drain current	Pulse	I <sub>DP</sub>	-200	ША

#### Absolute Maximum Ratings (Ta = 25 °C) (Common to the Q1, Q2)

Characteristics	Symbol	Rating	Unit	
Drain power dissipation	P <sub>D</sub> (Note 1)	200	mW	
Channel temperature	T <sub>ch</sub>	150	°C	
Storage temperature range	T <sub>stg</sub>	-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Total rating

Start of commercial production 2008-03

Unit: mm

#### Q1 Electrical Characteristics (Ta = 25°C)

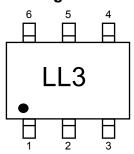
Chara	cteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Gate leakage curr	ent	I <sub>GSS</sub>	$V_{GS}=\pm 10~V,~V_{DS}=0V$		_	—	±10	μA
Drain-source brea	akdown voltage	V (BR) DSS	$I_D = 0.1 \text{ mA}, V_{GS} = 0V$		20	_	_	V
Drain cutoff currer	nt	I <sub>DSS</sub>	$V_{DS} = 20 V, V_{GS} = 0V$		_	_	1	μA
Gate threshold vol	tage	V <sub>th</sub>	$V_{DS} = 3 V, I_D = 1 mA$		0.4	_	1.0	V
Forward transfer a	idmittance	Y <sub>fs</sub>	$V_{DS} = 3 V, I_{D} = 50 mA$	(Note 2)	115	_	_	mS
		R <sub>DS</sub> (ON)	I <sub>D</sub> = 50 mA, V <sub>GS</sub> = 4 V	(Note 2)	_	1.5	3	Ω
	$I_{D} = 50 \text{ mA}, \text{ V}_{GS} = 2.5 \text{ V}$		(Note 2)	_	2	4		
Drain-source ON-resistance			$I_{D} = 5 \text{ mA}, V_{GS} = 1.5 \text{ V}$	(Note 2)	_	3	8	
			$I_{D} = 5 \text{ mA}, V_{GS} = 1.2 \text{ V}$	(Note 2)		5	20	
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = 3 V, V <sub>GS</sub> = 0V, f = 1 MHz		_	9.5	_	pF
Reverse transfer capacitance		C <sub>rss</sub>			_	4.1	_	
Output capacitance		C <sub>oss</sub>			_	9.5	—	
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = 3 \text{ V}, \text{ I}_{D} = 50 \text{ mA},$ $V_{GS} = 0 \text{ to } 2.5 \text{ V}$		_	115	_	
	Turn-off time	t <sub>off</sub>			_	300	_	ns
Drain-source forward voltage		V <sub>DSF</sub>	$I_D = -180 \text{ mA}, V_{GS} = 0 \text{V}$	(Note 2)	_	-0.9	-1.2	V

#### Q2 Electrical Characteristics (Ta = 25°C)

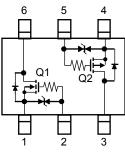
Charac	teristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Gate leakage curre	ent	I <sub>GSS</sub>	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$			—	±10	μA
Drain-source breat	kdown voltage	V (BR) DSS	$I_D = -0.1 \text{ mA}, V_{GS} = 0 \text{ V}$		-20	_	_	V
Drain cutoff current	t	I <sub>DSS</sub>	$V_{DS} = -20 V, V_{GS} = 0 V$			_	-1	μA
Gate threshold volt	rreshold voltage $V_{th}$ $V_{DS} = -3 V, I_D = -1 mA$			-0.4	_	-1.0	V	
Forward transfer admittance		Y <sub>fs</sub>	$V_{DS} = -3 V, I_D = -50 mA$	(Note 2)	77	_	_	mS
Drain–source ON-resistance		R <sub>DS</sub> (ON)	$I_D$ = -50 mA, $V_{GS}$ = -4 V	(Note 2)	_	4.3	8	Ω
			$I_{D}$ = -50 mA, $V_{GS}$ = -2.5 V	(Note 2)		5.6	11	
			$I_{D} = -5 \text{ mA}, V_{GS} = -1.5 \text{ V}$	(Note 2)	_	8.2	22	
			$I_D = -2 \text{ mA}, V_{GS} = -1.2 \text{ V}$	(Note 2)	_	11	44	
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = -3 V, V <sub>GS</sub> = 0 V, f = 1 MHz			12.2		
Reverse transfer capacitance		C <sub>rss</sub>				6.5		pF
Output capacitance		C <sub>oss</sub>				10.4		
Switching time	Turn-on time	t <sub>on</sub>	V <sub>DD</sub> = -3 V, I <sub>D</sub> = -50 mA, V <sub>GS</sub> = 0 to -2.5 V		_	175	_	
	Turn-off time	t <sub>off</sub>				251	_	ns
Drain-source forward voltage		V <sub>DSF</sub>	$I_D = 100 \text{ mA}, V_{GS} = 0 \text{ V}$	(Note 2)	_	0.83	1.2	V

Note 2: Pulse test

#### Marking



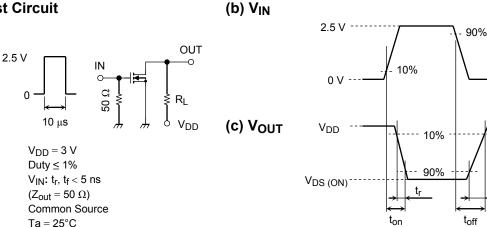
#### Equivalent Circuit (top view)



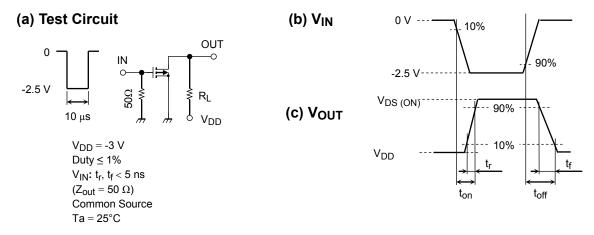
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### Q1 Switching Time Test Circuit

(a) Test Circuit



#### **Q2 Switching Time Test Circuit**



#### Q1 Usage Considerations

Let V<sub>th</sub> be the voltage applied between gate and source that causes the drain current (I<sub>D</sub>) to below (1 mA for the Q1 of the SSM6L35FU). Then, for normal switching operation,  $V_{GS(on)}$  must be higher than  $V_{th}$ , and  $V_{GS(off)}$  must be lower than  $V_{th}$ . This relationship can be expressed as:  $V_{GS(off)} < V_{th} < V_{GS(on)}$ . Take this into consideration when using the device.

#### **Q2 Usage Considerations**

Let  $V_{th}$  be the voltage applied between gate and source that causes the drain current (I<sub>D</sub>) to below (-1 mA for the Q2 of the SSM6L35FU). Then, for normal switching operation,  $V_{GS(on)}$  must be higher than  $V_{th}$ , and  $V_{GS(off)}$  must be lower than  $V_{th}$ . This relationship can be expressed as:  $V_{GS(off)} < V_{th} < V_{GS(on)}$ .

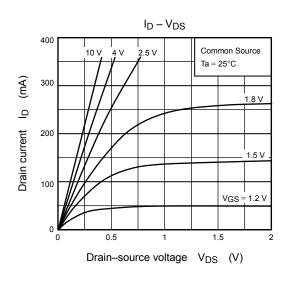
Take this into consideration when using the device.

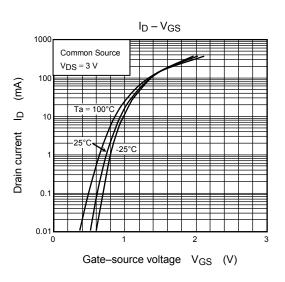
#### **Handling Precaution**

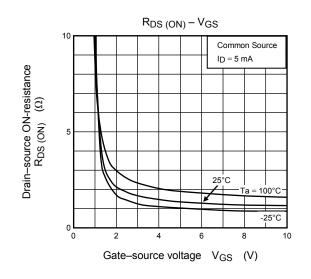
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

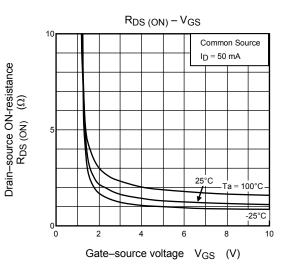
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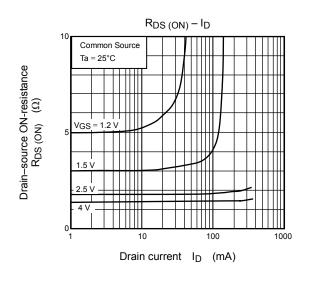
### Q1 (N-ch MOSFET)

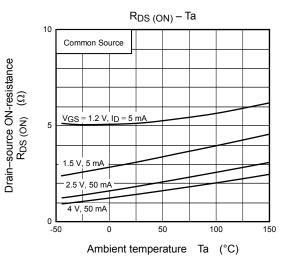






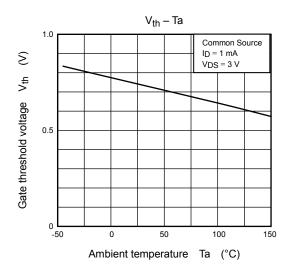


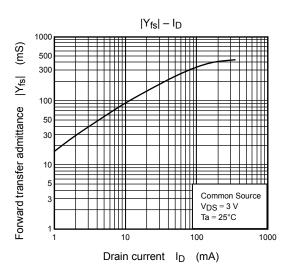


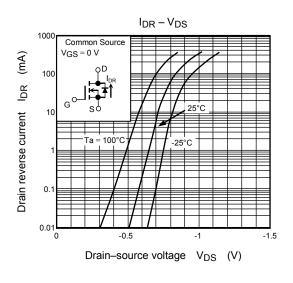


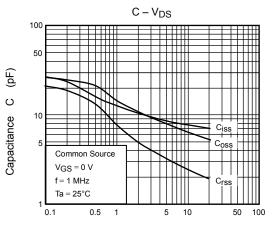
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### Q1 (N-ch MOSFET)

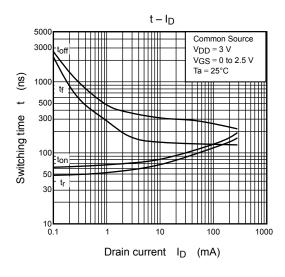






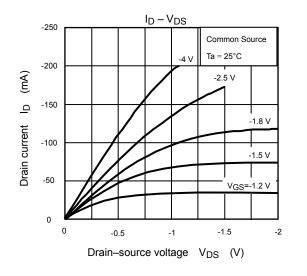


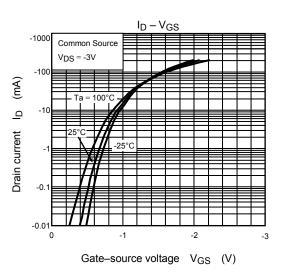


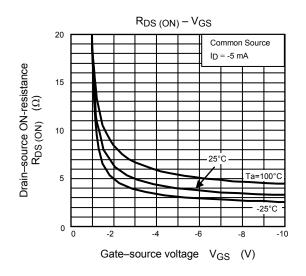


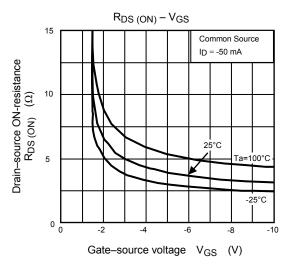
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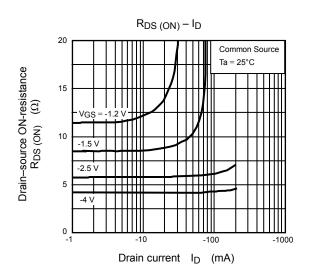
### Q2 (P-ch MOSFET)







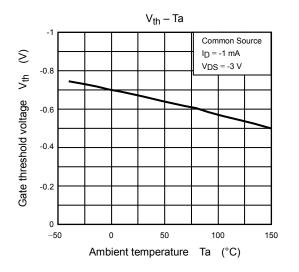


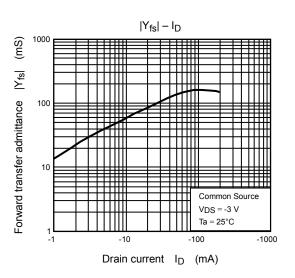


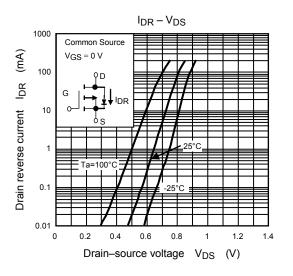
R<sub>DS (ON)</sub> – Ta 20 Common Source Drain–source ON-resistance  $R_{DS}$  (ON) ( $\Omega$ ) VGS -1.2 V, ID=-2 mA 15 1.5 V, -5 m/ 10 2.5 V, -50 mA 4 V. -50 mA 5 0 -50 0 50 100 150 Ambient temperature Ta (°C)

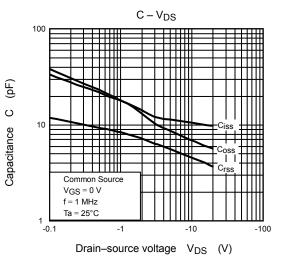
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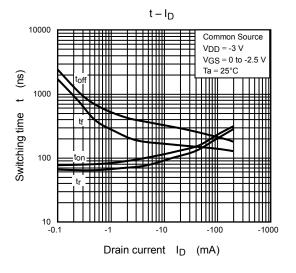
#### Q2 (P-ch MOSFET)



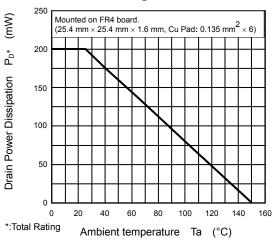








P<sub>D</sub> \*– Ta



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